



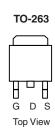
P-Channel 60-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A) ^d	
- 60	0.0069 at V _{GS} = - 10 V	- 110	
	0.0088 at V _{GS} = - 4.5 V	- 110	

FEATURES

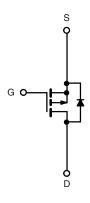
- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance





Ordering Information: SUM110P06-07L

SUM110P06-07L-E3 (Lead (Pb)-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 2$	25 °C, unless other	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 60	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current ^d	T _C = 25 °C	- I _D	- 110	Α	
$(T_J = 175 ^{\circ}C)$	T _C = 125 °C		- 95		
Pulsed Drain Current		I _{DM}	- 240	- A	
Avalanche Current	L = 0.1 mH	I _{AS}	- 75	1	
Single Pulse Avalanche Energy ^a	L = 0.1 IIII1	E _{AS}	281	mJ	
Paragraphical in a street in a	T _C = 25 °C	D	375 ^c	w	
Power Dissipation	T _A = 25 °C ^b	P _D -	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Unit	
Junction-to-Ambient	PCB Mount ^b	R_{thJA}	40	°C/W	
Junction-to-Case	ction-to-Case		0.4	C/VV	

Notes:

- a. Duty cycle \leq 1 %.
- b. When Mounted on 1" square PCB (FR-4 material).
- c. See SOA curve for voltage derating.
- d. Limited by package.
- * Pb containing terminations are not RoHS compliant, exemptions may apply.

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SUM110P06-07L

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SPECIFICATIONS $T_J = 25^{\circ}$					1		
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			- 50	μΑ	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 120			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V, I _D = - 30 A		0.0055	0.0069	Ω	
	r	V_{GS} = - 10 V, I_D = - 30 A, T_J = 125 °C			0.0115		
	^r DS(on)	V _{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C			0.0138		
		V _{GS} = - 4.5 V, I _D = - 20 A		0.007	0.0088		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			11400		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$		1200			
Reverse Transfer Capacitance	C _{rss}	1		900			
Total Gate Charge ^c	Qq			230	345	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -110 \text{ A}$		50			
Gate-Drain Charge ^c	Q _{gd}]		60			
Gate Resistance	R_q	f = 1.0 MHz		3		Ω	
Turn-On Delay Time ^c	t _{d(on)}			20	30		
Rise Time ^c	t _r	V_{DD} = - 30 V, R_{L} = 0.27 Ω		160	240	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 110 A, $V_{GEN} =$ - 10 V, $R_g = 2.5 \Omega$		200	300		
Fall Time ^c	t _f	1		240	360		
Source-Drain Diode Ratings and Cha	aracteristics	Γ _C = 25 °C ^b					
Continuous Current	I _S				- 110		
Pulsed Current	I _{SM}				- 240	Α	
Forward Voltage ^a	V _{SD}	I _F = - 85 A, V _{GS} = 0 V		- 1.0	-1.5	V	
Reverse Recovery Time	t _{rr}			65	100	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = - 85 A, di/dt = 100 A/μs		- 4.2	- 6.3	A	
Reverse Recovery Charge	Q _{rr}	<u>'</u>		0.14	0.32	μС	

Notes:

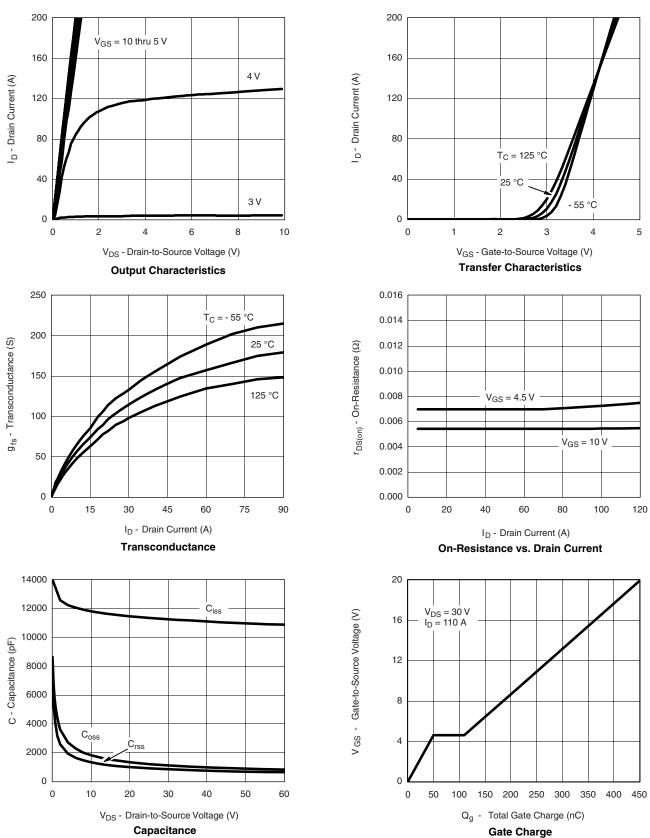
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

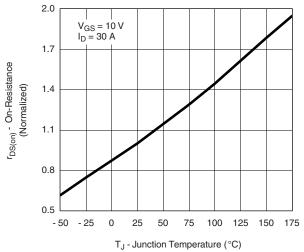


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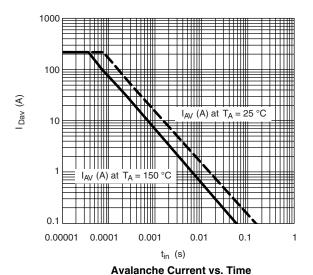
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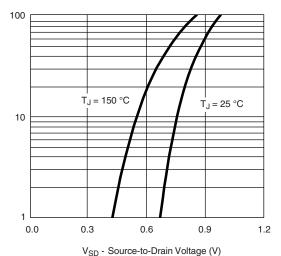
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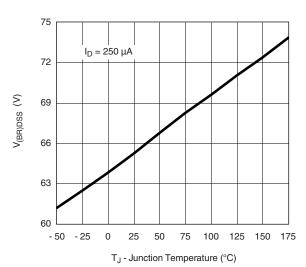
On-Resistance vs. Junction Temperature



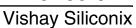
Is - Source Current (A)



Source-Drain Diode Forward Voltage

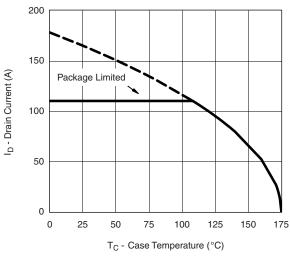


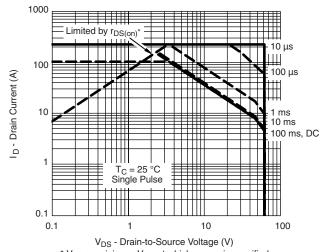
Drain Source Breakdown vs. Junction Temperature



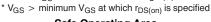


THERMAL RATINGS

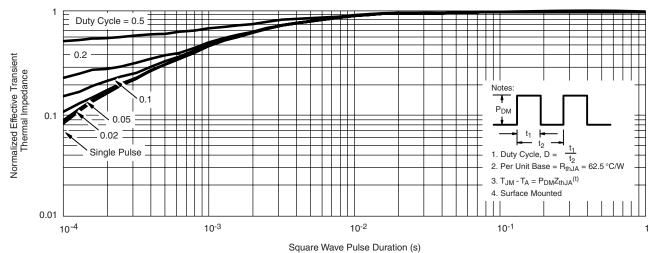




Maximum Avalanche and Drain Current vs. Case Temperature







Normalized Thermal Transient Impedance, Junction-to-Case

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